

SKM 500GA123D

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SEMITRANS® 4

IGBT Modules

SKM 500GA123D

SKM 500GA123DS

Features

- MOS input (voltage controlled)
- N channel, homogeneous Si
- Low inductance case
- Very low tail current with low temperature dependence
- High short circuit capability, self limiting to $6 \times I_{Cnom}$
- Latch-up free
- Fast & soft CAL diodes
- Isolated copper baseplate using DBC Direct Copper Bonding Technology
- Large clearance (12 mm) and creepage distances (20 mm)

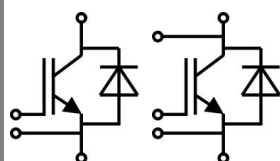
Typical Applications

- AC inverter drives
- UPS

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Absolute Maximum Ratings			$T_c = 25\text{ }^{\circ}\text{C}$, unless otherwise specified	
Symbol	Conditions		Values	Units
IGBT				
V_{CES}	$T_j = 25\text{ }^{\circ}\text{C}$		1200	V
I_C	$T_j = 150\text{ }^{\circ}\text{C}$	$T_{case} = 25\text{ }^{\circ}\text{C}$	500	A
		$T_{case} = 80\text{ }^{\circ}\text{C}$	420	A
I_{CRM}	$I_{CRM}=2\times I_{Cnom}$		800	A
V_{GES}			± 20	V
t_{psc}	$V_{CC} = 600\text{ V}; V_{GE} \leq 20\text{ V}; T_j = 125\text{ }^{\circ}\text{C}$ $V_{CES} < 1200\text{ V}$		10	μs
Inverse Diode				
I_F	$T_j = 150\text{ }^{\circ}\text{C}$	$T_{case} = 25\text{ }^{\circ}\text{C}$	500	A
		$T_{case} = 80\text{ }^{\circ}\text{C}$	350	A
I_{FRM}	$I_{FRM}=2\times I_{Fnom}$		800	A
I_{FSM}	$t_p = 10\text{ ms}; \sin.$	$T_j = 150\text{ }^{\circ}\text{C}$	3600	A
Module				
$I_{t(RMS)}$			500	A
T_{vj}			- 40 ... + 150	$^{\circ}\text{C}$
T_{stg}			- 40 ... + 125	$^{\circ}\text{C}$
V_{isol}	AC, 1 min.		2500	V

Characteristics			T _c = 25 °C, unless otherwise specified			
Symbol	Conditions		min.	typ.	max.	Units
IGBT						
V _{GE(th)}	V _{GE} = V _{CE} , I _C = 16 mA		4,5	5,5	6,5	V
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES} T _j = 25 °C			0,1	0,3	mA
V _{CE0}	T _j = 25 °C			1,4	1,6	V
	T _j = 125 °C			1,6	1,8	V
r _{CE}	V _{GE} = 15 V T _j = 25°C			2,75	3,5	mΩ
	T _j = 125°C			3,75	4,75	mΩ
V _{CE(sat)}	I _{Cnom} = 400 A, V _{GE} = 15 V T _j = °C _{chiplev.}			2,5	3	V
C _{ies}				26	40	nF
C _{oes}	V _{CE} = 25, V _{GE} = 0 V f = 1 MHz			4	5,2	nF
C _{res}				2	2,6	nF
R _{Gint}	T _j = °C			1,25		Ω
t _{d(on)}	R _{Gon} = 3,3 Ω	V _{CC} = 600V I _{Cnom} = 400A		250	600	ns
t _r				170	340	ns
E _{on}	R _{Goff} = 3,3 Ω	T _j = 125 °C		45		mJ
t _{d(off)}		V _{GE} = ± 15V		900	1100	ns
t _f				100	125	ns
E _{off}						mJ
R _{th(j-c)}	per IGBT				0,041	K/W



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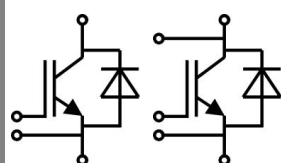
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Characteristics

Symbol	Conditions	min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{F\text{nom}} = 400 \text{ A}$; $V_{GE} = 0 \text{ V}$ $T_j = 25^\circ\text{C}_{\text{chiplev.}}$		2	2,5	V
	$T_j = 125^\circ\text{C}_{\text{chiplev.}}$		1,8		V
V_{F0}	$T_j = 25^\circ\text{C}$		1,1	1,2	V
	$T_j = 125^\circ\text{C}$				V
r_F	$T_j = 25^\circ\text{C}$		2,3	3,3	mΩ
	$T_j = 125^\circ\text{C}$				mΩ
I_{RRM}	$I_{F\text{nom}} = 400 \text{ A}$ $T_j = 25^\circ\text{C}$		90		A
Q_{rr}	$di/dt = 2000 \text{ A}/\mu\text{s}$		15		μC
E_{rr}	$V_{GE} = 0 \text{ V}$; $V_{CC} = 600 \text{ V}$				mJ
$R_{th(j-c)D}$	per diode			0,09	K/W
Freewheeling Diode					
$V_F = V_{EC}$	$I_{F\text{nom}} = \text{A}$; $V_{GE} = \text{V}$ $T_j = ^\circ\text{C}_{\text{chiplev.}}$				V
V_{F0}	$T_j = 25^\circ\text{C}$				V
	$T_j = 125^\circ\text{C}$				V
r_F	$T_j = 25^\circ\text{C}$				V
	$T_j = 125^\circ\text{C}$				V
I_{RRM}	$I_{F\text{nom}} = \text{A}$ $T_j = ^\circ\text{C}$				A
Q_{rr}					μC
E_{rr}	$V_{GE} = 0 \text{ V}$; $V_{CC} = 600 \text{ V}$				mJ
	per diode				K/W
Module					
L_{CE}			15	20	nH
$R_{CC+EE'}$	res., terminal-chip $T_{\text{case}} = 25^\circ\text{C}$		0,18		mΩ
	$T_{\text{case}} = 125^\circ\text{C}$		0,22		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
M_s	to heat sink M6	3		5	Nm
M_t	to terminals M6 (M4)	2,5 (1,1)		5 (2)	Nm
w				330	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

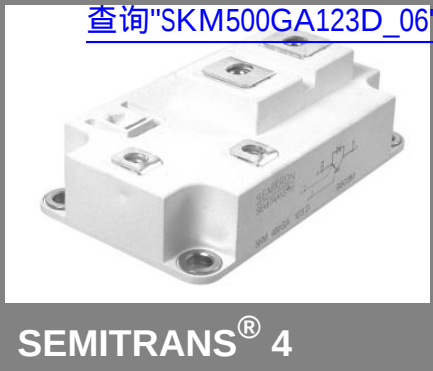
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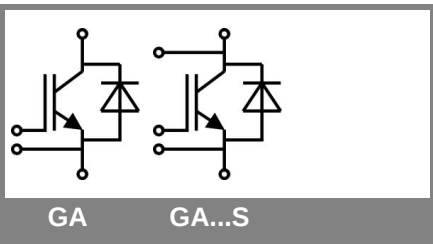
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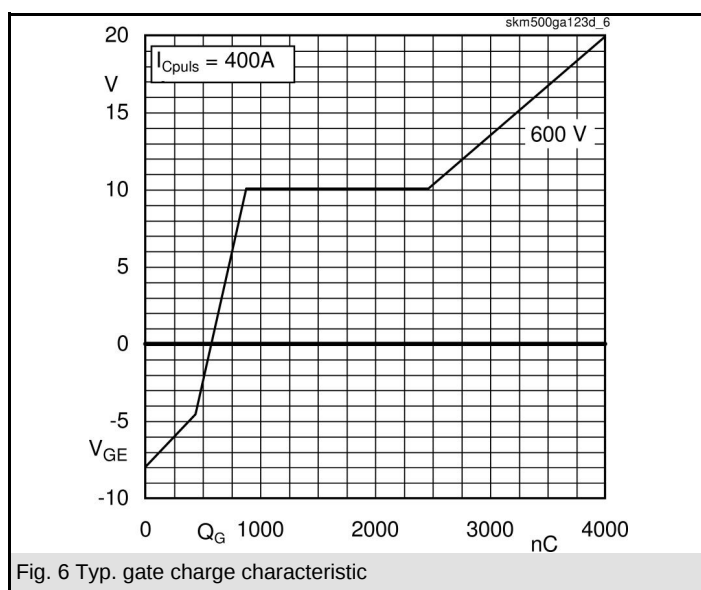
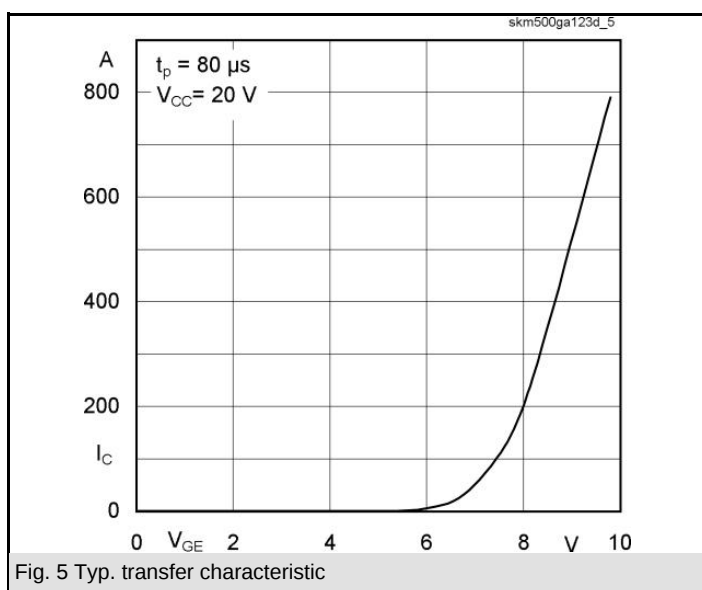
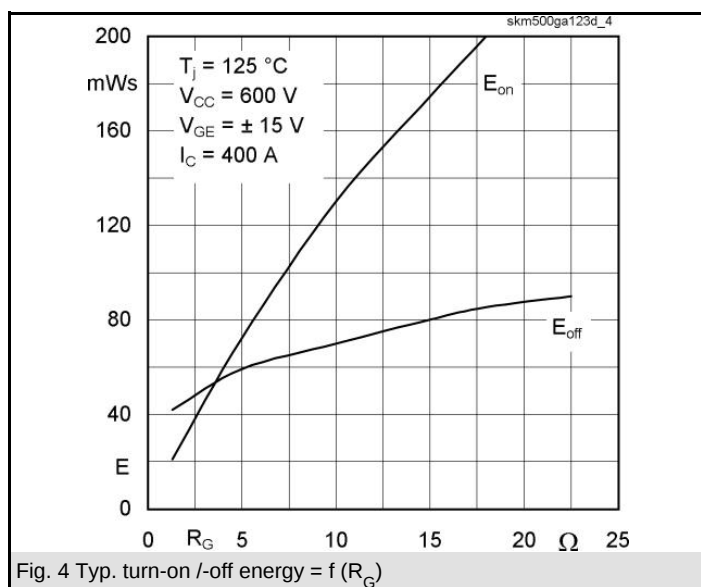
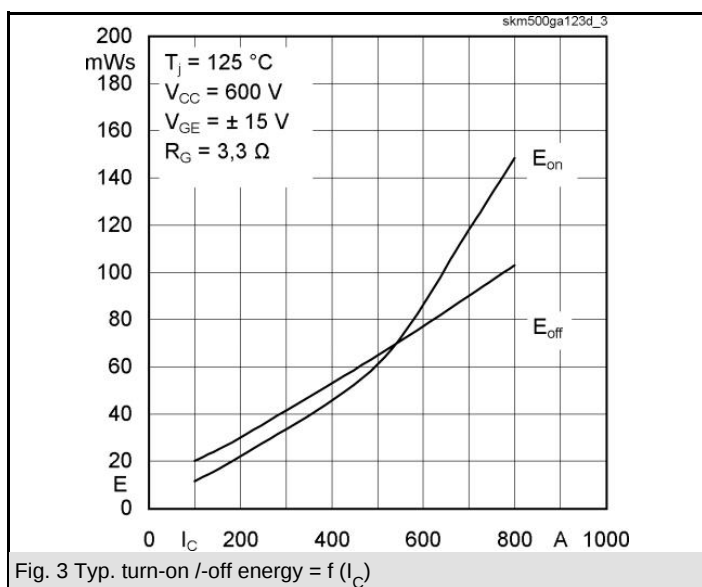
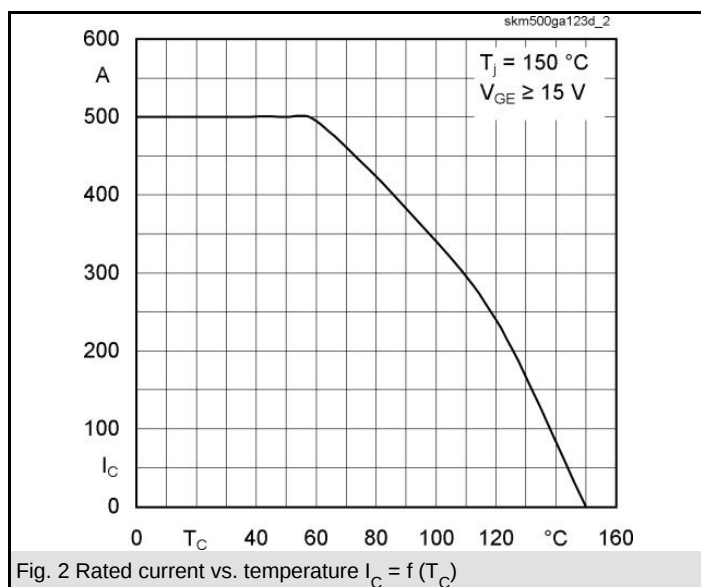
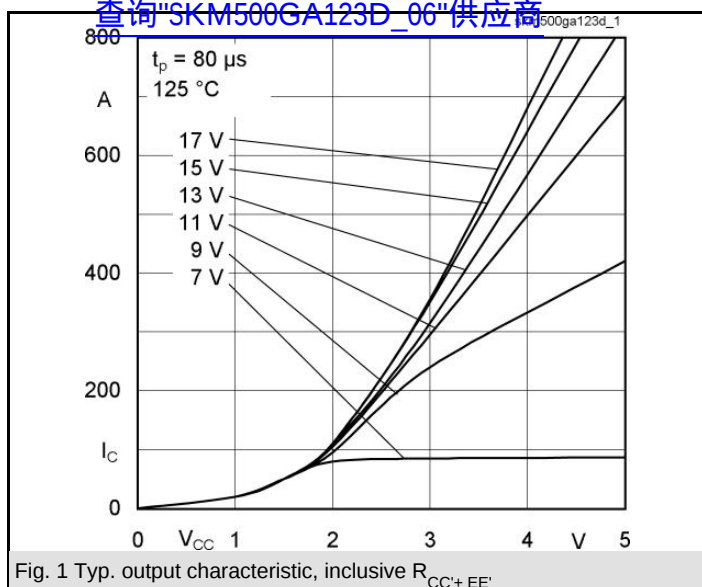
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Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$			
R_i	$i = 1$	29	mk/W
R_i	$i = 2$	10	mk/W
R_i	$i = 3$	1,8	mk/W
R_i	$i = 4$	0,2	mk/W
τ_{ui}	$i = 1$	0,04	s
τ_{ui}	$i = 2$	0,0189	s
τ_{ui}	$i = 3$	0,0017	s
τ_{ui}	$i = 4$	0,001	s
$Z_{th(j-c)D}$			
R_i	$i = 1$	60	mk/W
R_i	$i = 2$	23	mk/W
R_i	$i = 3$	6,2	mk/W
R_i	$i = 4$	0,8	mk/W
τ_{ui}	$i = 1$	0,0366	s
τ_{ui}	$i = 2$	0,042	s
τ_{ui}	$i = 3$	0,0009	s
τ_{ui}	$i = 4$	0,002	s

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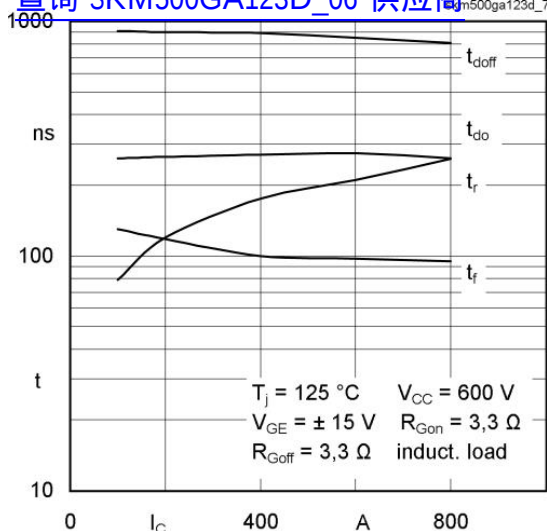


Fig. 7 Typ. switching times vs. I_C

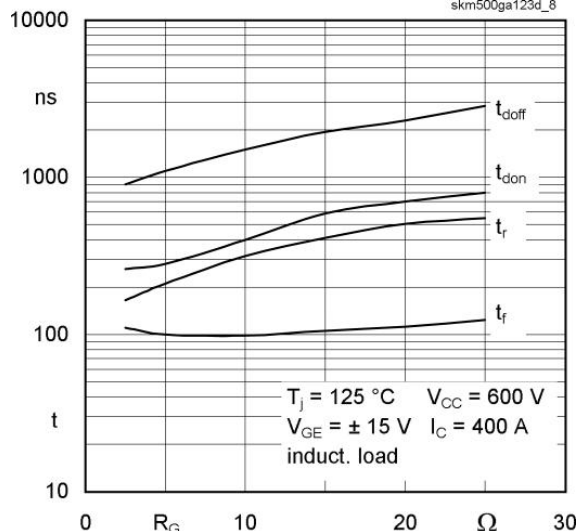


Fig. 8 Typ. switching times vs. gate resistor R_G

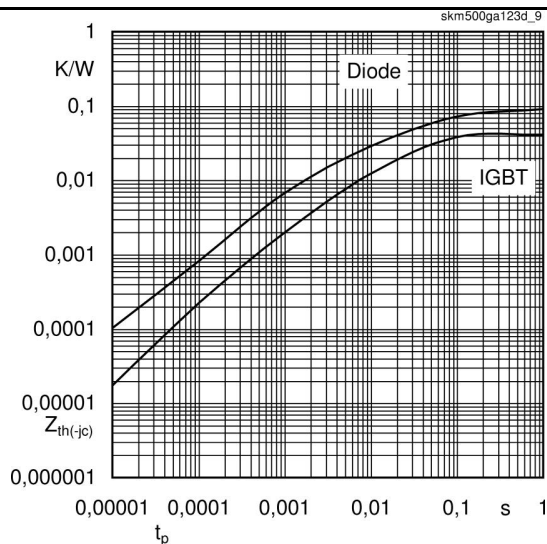


Fig. 9 Transient thermal impedance

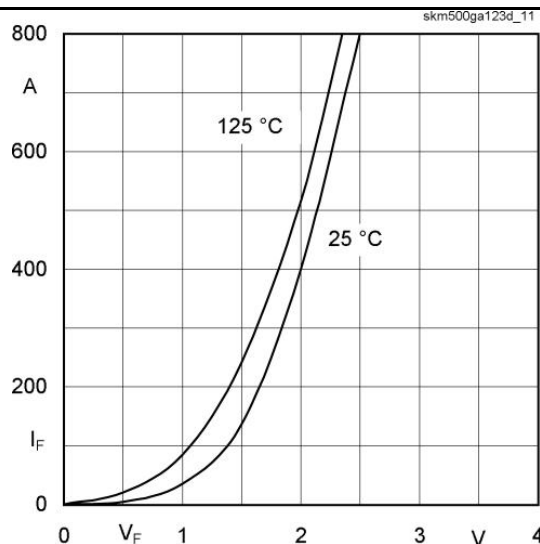


Fig. 10 CAL diode forward characteristic

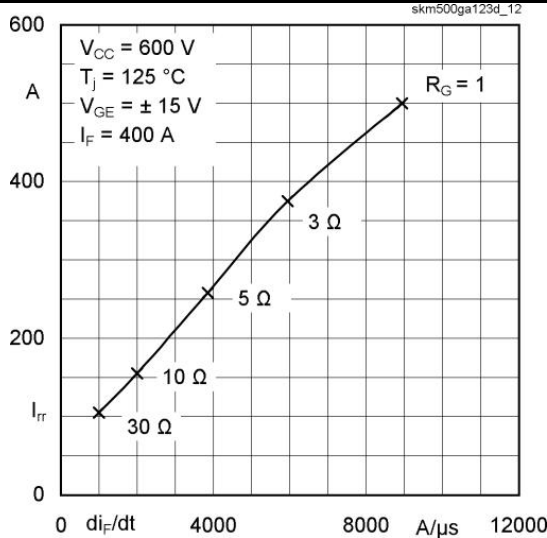


Fig. 11 Typ. CAL diode peak reverse recovery current

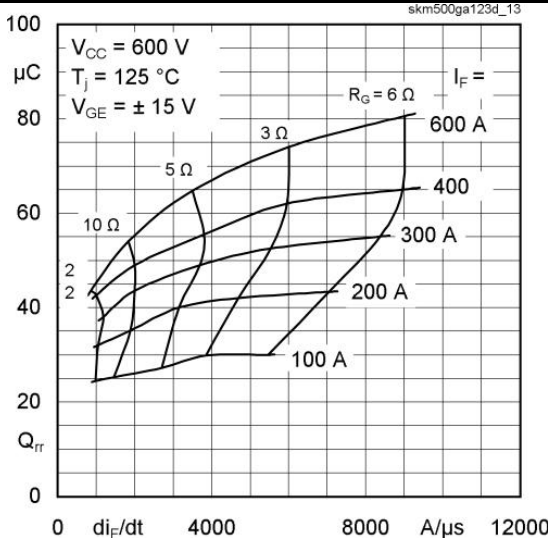


Fig. 12 Typ. CAL diode peak reverse recovery charge

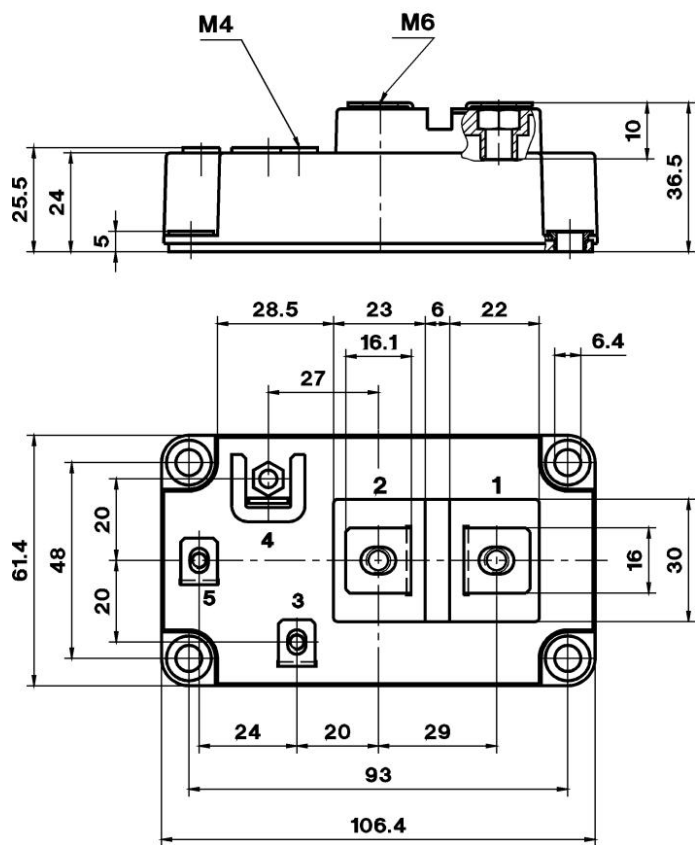
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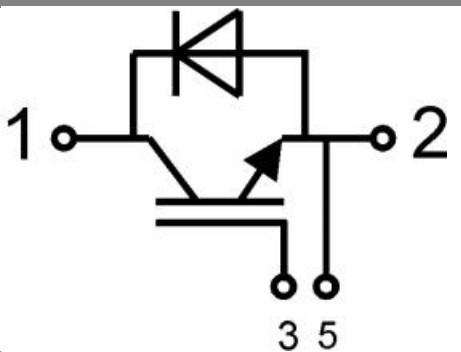
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